SWITCHMODE Power Rectifier

DPAK Surface Mount Package

These state-of-the-art devices are designed for use in switching power supplies, inverters and as free wheeling diodes.

Features

- Low Forward Voltage Drop
- Low Leakage
- Ultra-Fast Recovery Time
- Pb-Free Package is Available

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 0.4 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Rated Reverse Voltage	V _R	300	V
Average Rectified Forward Current	IF	3	Α
Non-Repetitive Peak Surge Current	I _{FSM}	75	Α
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +175	°C

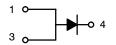
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



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ULTRAFAST RECTIFIER 3 A, 300 V





DPAK CASE 369C





U330 = Specific Device Code A = Assembly Location

Y = Year WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping [†]
MURD330T4	DPAK	2500/Tape & Reel
MURD330T4G	DPAK (Pb-Free)	2500/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance – Junction-to-Case	$R_{\theta JC}$	2	°C/W
Thermal Resistance – Junction-to-Ambient (Note 1)	$R_{\theta JA}$	49	°C/W

ELECTRICAL CHARACTERISTICS

Rating		Symbol	Value	Unit
Maximum Instantaneous Forward Voltage Drop ($I_F = 3 \text{ A}, T_J = 25^{\circ}\text{C}$) ($I_F = 3 \text{ A}, T_J = 150^{\circ}\text{C}$)		V _F	1.15 0.92	V
Maximum Instantaneous Reverse Current $(T_J = 25^{\circ}C, 300 \text{ V})$ $(T_J = 150^{\circ}C, 300 \text{ V})$		I _R	5 500	μΑ
Maximum Reverse Recovery Time (IF = 1 Amp, di/dt = 50 A/ μ s, V _R = 30 V, T _J = 25°C)		t _{rr}	50	ns
ESD Ratings:	Machine Model = C Human Body Model = 3B		> 400 > 8000	V

^{1.} Rating applies when surface mounted on a 700 mm², 1 oz Cu heat spreader.

TYPICAL CHARACTERISTICS

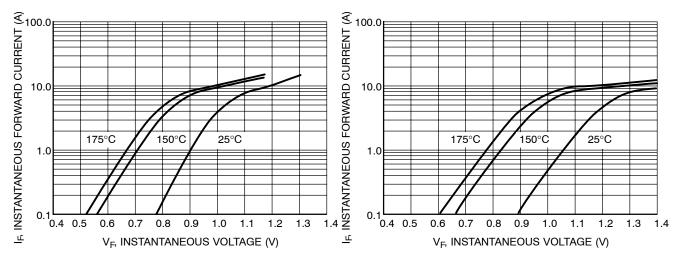


Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage

TYPICAL CHARACTERISTICS

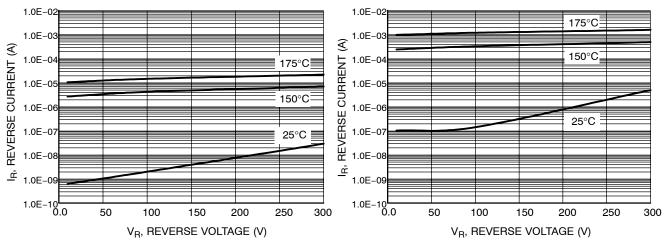


Figure 3. Typical Reverse Voltage

Figure 4. Maximum Reverse Voltage

DC

4.5

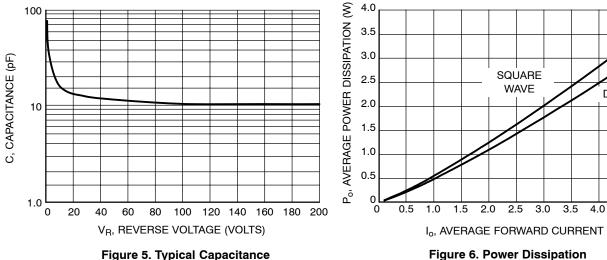


Figure 5. Typical Capacitance

6.0 I_F, AVERAGE FORWARD CURRENT (A) $R_{\theta JC} = 2^{\circ}C/W$ $R_{\theta JC} = 2^{\circ}C/W$ 5.0 T_{.1} = 175°C/W 4.0 DC DC $T_J = 175^{\circ}C/W$ SQUARE WAVE 3.0 SQUARE 2.0 WAVE 1.0 0 160 170 180 130 140 150 0 20 80 100 120 160 180 200 T_C, CASE TEMPERATURE (°C) TA, AMBIENT TEMPERATURE (°C)

Figure 7. Current Derating, Case

Figure 8. Current Derating, Ambient

110

100

6.0

5.0

4.0

3.0

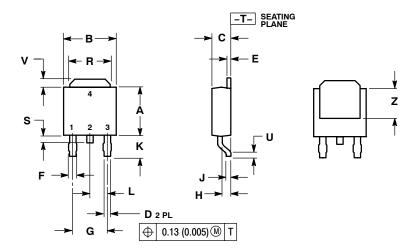
2.0

1.0

IF, AVERAGE FORWARD CURRENT (A)

PACKAGE DIMENSIONS

DPAK CASE 369C-01 ISSUE O

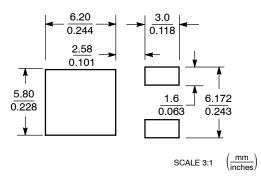


NOTES:

- 1. DIMENSIONING AND TOLERANCING
- PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.235	0.245	5.97	6.22
В	0.250	0.265	6.35	6.73
၁	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
Е	0.018	0.023	0.46	0.58
F	0.037	0.045	0.94	1.14
G	0.180 BSC		4.58 BSC	
Η	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29 BSC	
R	0.180	0.215	4.57	5.45
S	0.025	0.040	0.63	1.01
C	0.020		0.51	
٧	0.035	0.050	0.89	1.27
Z	0.155		3.93	

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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